S03P1428US00 7449/71419



DECLARATION AND POWER OF ATTORNEY

As a below-named inventor, I hereby declare that:

My residence, post office address, and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

DEVICE AND	me invention entitled: METHOD FOR PROCES AND COMPUTER-REA				
the specification of (check one)	which				()
	X is attache	d hereto.			
•	was filed	on		·	a
	Application Serial	No			· · · · · · · · · · · · · · · · · · ·
	and was amended	on			
w .			(if ap	plicable)	
this application in a I hereby claim fore application(s) for pa	uty to disclose informaticcordance with Title 37 ign priority benefits unitent or inventor's certification inventor's certification.	, Code of Federal Regr der Title 35, United S ficate listed below and	lations, Section tates Code, Se have also iden	n 1.56(a). ction 119 of tified below	any foreign
				· . · ·	•
Prior Foreign Appli	cation(s)			Priorit	y Claimed
Number	Country	Filing Date		<u>Yes</u>	<u>No</u>
P2002-362666	<u>Japan</u>	DECEMBER	13,2002	<u>X</u>	
			· · ·		

S03P1428US00 7449/71419

Declaration and Power of Attorney

Page 2

I hereby claim the benefit under Title 35, United States Code, Section 120 of any United States Application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, Section 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

And I hereby appoint Jay H. Ma	Paul Teng, Reg. No. 40,8	37; William E. Pelton, I

And I hereby appoint Jay H. Maioh, Reg. No. 27,213; Paul Teng, Reg. No. 40,837; William E. Pelton, Reg. No. 25,702; Peter J. Phillips, Reg. No. 29,691; Norman H. Zivin, Reg. No. 25,385; John P. White, Reg. No. 28,678; and Robert D. Katz, Reg. No. 30,141; and each and all of them, all c/o Cooper & Dunham, 1185 Avenue of the Americas, New York, NY 10036 (Tel. (212) 278-0400), my attorneys, each with full power of substitution and revocation, to receive the patent, to transact all business in the Patent and Trademark Office connected therewith and to file any International Applications which are based thereon under the provisions of the Patent Cooperation Treaty.

Please address all communications, and direct all telephone calls, regarding this application to

JAY H. MAIOLI Cooper & Dunham LLP 1185 Avenue of the Americas New York, New York 10036 Tel. (212) 278-0400 Reg. No. 27,213

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or		
First joint inventor	Tetsujiro Kondo	•
Inventor's signature	Tetupo tondo	
Citizenship	Japanese	Date of Signature Apr. 14. Vers
Residence	Tokyo, Japan	· .
Post Office Address	c/o Sony Corporation, 7-35 Kitashinagawa, 6-	Chome,
	Shinagawa-ku, Tokyo, Japan	<u> </u>

Full name of	Nakanaki Asalmea
Second joint inventor	
Inventor's signature _	Nobuyuki azakura
Citizenship <u>J</u>	Date of Signature April 5
Residence 2	Tokyo, Japan
Post Office Address	c/o Sony Corporation, 7-35 Kitashinagawa, 6-Chome,
	Shinagawa-ku, Tokyo, Japan
Full name of Third joint inventor	Takeharu Nishikata
Inventor's signature	Jakeharu Nishikata
Citizenship	Japanese Date of Signature May, 6,
Residence	Chiba, Japan
Post Office Address	c/o Sony Corporation, 7-35 Kitashinagawa, 6-Chome,
	Shinagawa-ku, Tokyo, Japan
Full name of Fourth joint invento	Takuo Morimura
Inventor's signature	of P. Marianas
7	JapaneseDate of Signature May
•	awa, Japan
Post Office Address	Chama
	Shinagawa-ku, Tokyo, Japan

S03P1428US00 7449/71419

Full name of	
Fifth joint inventor	Kei Hiraizumi
·	11: 11:
Inventor's signature	Re Heraram
· · · · · · · · · · · · · · · · · · ·	
Citizenship Jap	Date of Signature May 6, 20
•	· ——
Residence Kanagawa	a, Japan
Post Office Address	c/o Sony Corporation, 7-35 Kitashinagawa, 6-Chome,
	Shinagawa-ku, Tokyo, Japan
•	
Full name of	
Sixth joint inventor	Hirosuke Nagano
Joint Inventor	
Inventor's signature	Idirosuke Nagano
Citizenship Jap	Date of Signature May 6 2005
Residence Kai	nagawa, Japan
Post Office Address	c/o Sony Corporation, 7-35 Kitashinagawa, 6-Chome,
	Shiwasawa ku, Takua Janan
	Shinagawa-ku, Tokyo, Japan
Full name of	
Seventh joint inventor	Sakon Yamamoto
Inventor's signature	Sakon yamamola
•	Marilia
Citizenship <u>Jap</u>	Date of Signature May 6, 200 S
Residence Tokyo, Jaj	pan
D-4 060 - Add	de Same Commencial II 25 Min. discourse (Champ
Post Office Address	c/o Sony Corporation, 7-35 Kitashinagawa, 6-Chome,
•	Shinagawa-ku, Tokyo, Japan